

HAT2266H

Silicon N Channel Power MOS FET Power Switching

REJ03G1370-0500 Rev.5.00 Apr 05, 2006

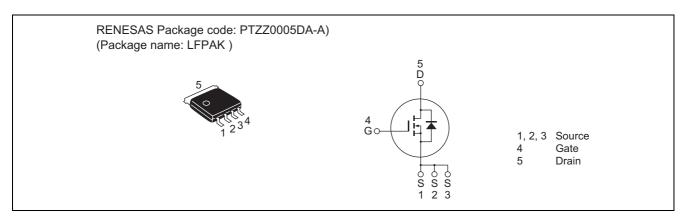
Features

- High speed switching
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance

 $R_{DS(on)} = 9.2 \text{ m}\Omega \text{ typ. (at } V_{GS} = 10 \text{ V})$

• Lead Free

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	30	A
Drain peak current	I _{D(pulse)} Note1	120	A
Body-drain diode reverse drain current	I _{DR}	30	A
Avalanche current	I _{AP} Note 2	20	A
Avalanche energy	E _{AR} Note 2	34	mJ
Channel dissipation	Pch Note3	23	W
Channel to Case Thermal Resistance	θch-C	5.44	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tch = 25°C, Rg \geq 50 Ω

3. $Tc = 25^{\circ}C$

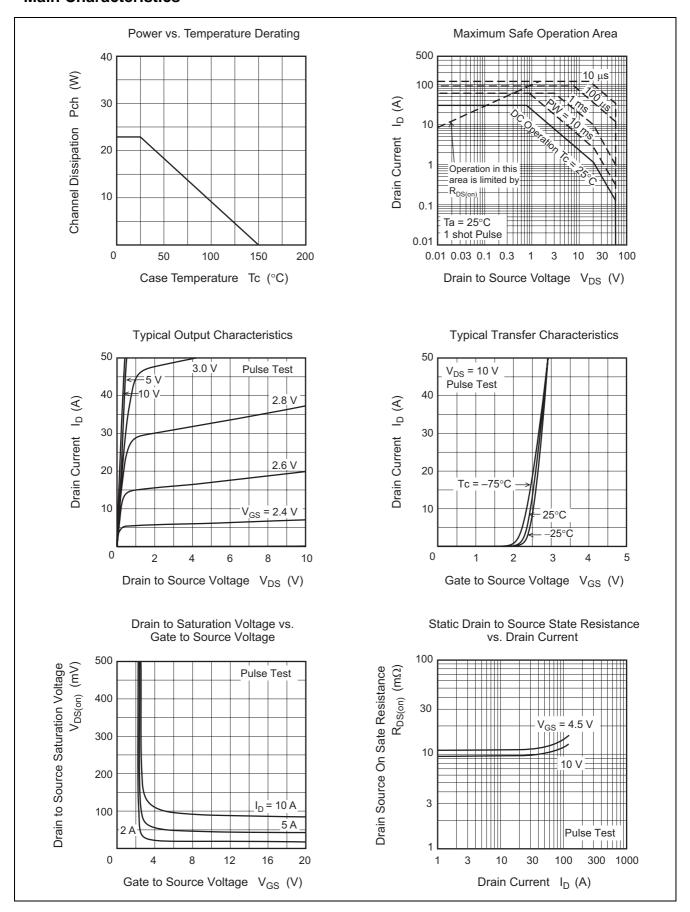
Electrical Characteristics

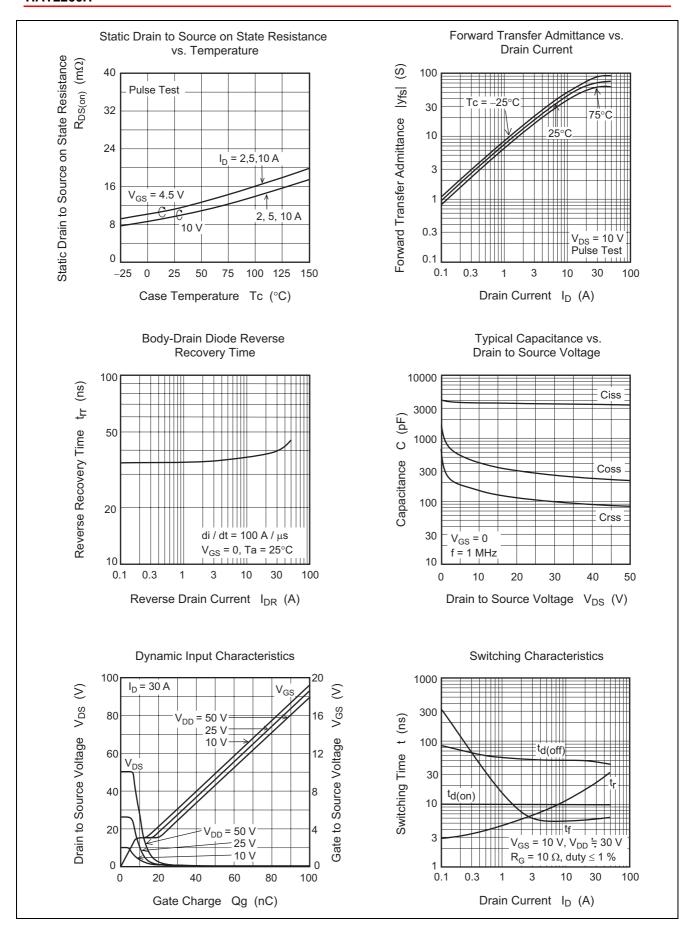
 $(Ta = 25^{\circ}C)$

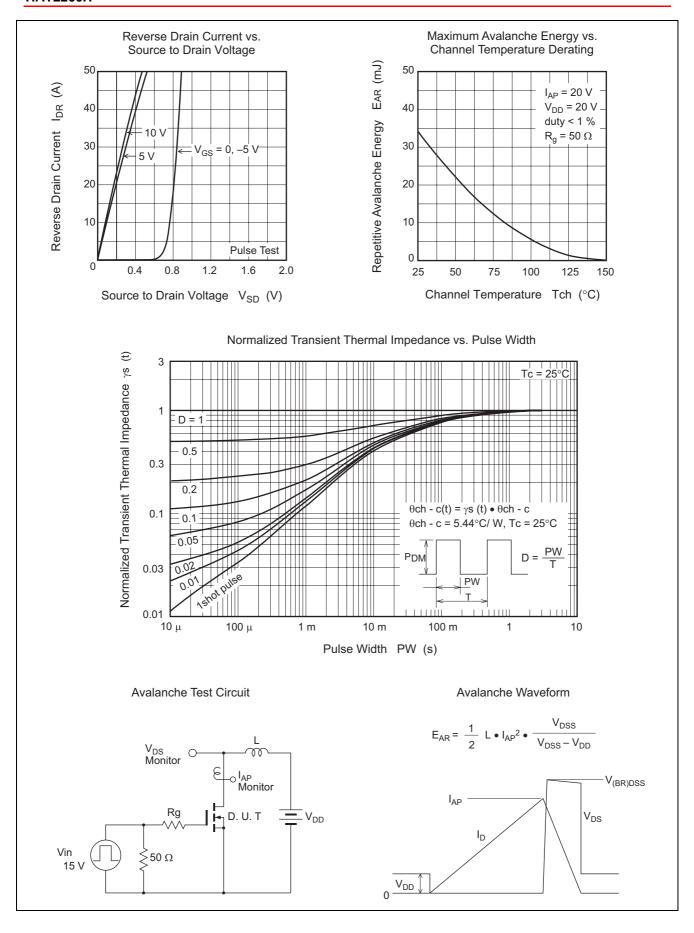
Item	Symbol	Min	Тур	Max	Unit	Test Conditions	
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$	
Gate to source leak current	I _{GSS}	_	_	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$	
Zero gate voltage drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 60 \text{ V}, V_{GS} = 0$	
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	_	2.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$	
Static drain to source on state	R _{DS(on)}	_	9.5	12	mΩ	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$	
resistance	R _{DS(on)}	_	11	16	mΩ	$I_D = 15 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$	
Forward transfer admittance	y _{fs}	35	70	_	S	$I_D = 30 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$	
Input capacitance	Ciss	_	3600	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$	
Output capacitance	Coss	_	400	_	pF	f = 1 MHz	
Reverse transfer capacitance	Crss	_	145	_	pF		
Gate resistance	Rg	_	0.5	_	Ω		
Total gate charge	Qg	_	25	_	nC	$V_{DD} = 25 \text{ V}, V_{GS} = 4.5 \text{ V},$ $I_{D} = 30 \text{ A}$	
Gate to source charge	Qgs	_	8.2	_	nC		
Gate to drain charge	Qgd	_	9	_	nC		
Turn-on delay time	t _{d(on)}	_	10	_	ns	$V_{GS} = 10 \text{ V}, I_D = 15 \text{ A},$	
Rise time	t _r	_	15	_	ns	$V_{DD} \cong 30 \text{ V}, R_L = 2 \Omega,$	
Turn-off delay time	t _{d(off)}	_	50	_	ns	$Rg = 4.7 \Omega$	
Fall time	t _f	_	5.5	_	ns		
Body-drain diode forward voltage	V_{DF}	_	0.84	1.10	V	$I_F = 30 \text{ A}, V_{GS} = 0^{\text{Note4}}$	
Body-drain diode reverse recovery	t _{rr}	_	40	_	ns	$I_F = 30 \text{ A}, V_{GS} = 0,$	
time						$di_F/dt = 100 A/ \mu s$	

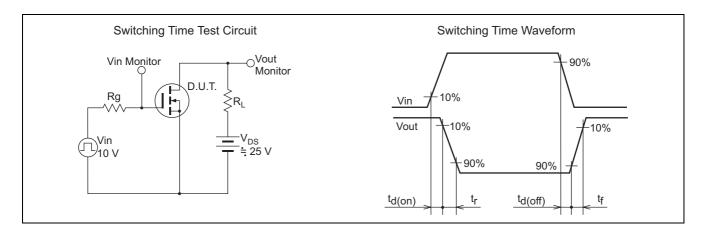
Notes: 4. Pulse test

Main Characteristics

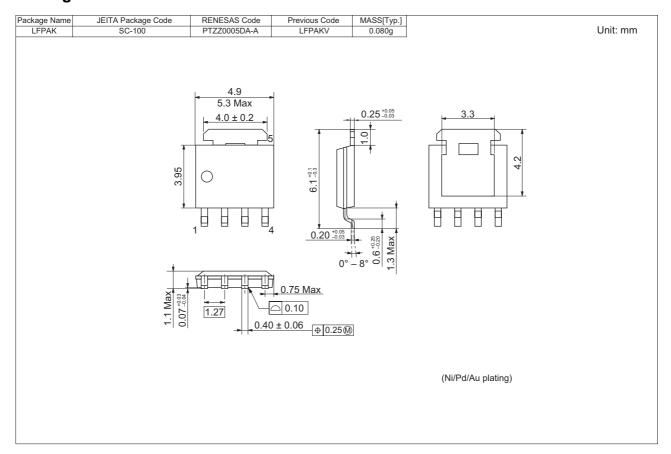








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2266H-EL-E	2500 pcs	Taping

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